Vishay Siliconix

Si1002R

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \ \mu A$	30	-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	29	-	mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	ID = 230 μA	-	-1.8	-			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4	-	1	V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$	-	-	± 30			
		$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$	-	-	± 1			
Zoro Cata Valtaga Drain Current	l	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$	-	-	3	1		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	2	-	-	А		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	0.450	0.560	Ω		
	Р	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$	-	0.500	0.620			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 1.8 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$	-	0.560	0.700			
		$V_{GS} = 1.5 \text{ V}, \text{ I}_{D} = 0.05 \text{ A}$	-	0.647	1.100			
Forward Transconductance	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	7.5	-	S		
Dynamic ^b		•	•		•	•		
Input Capacitance	Ciss		-	36	-	pF		
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	9	-			
Reverse Transfer Capacitance	C _{rss}		-	5	-			
T + 1 O + O	0	$V_{DS} = 15 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 0.5 \text{ A}$	-	1.2	2			
Total Gate Charge	Qg		-	0.72	1.2	nC		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.5 \text{ A}$	-	0.1	-			
Gate-Drain Charge	Q _{gd}		-	0.16	-			
Gate Resistance	R _g	f = 1 MHz	2.4	12.2	24.4	Ω		
Turn-On Delay Time	t _{d(on)}		-	6	15			
Rise Time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 37.5 \Omega$	-	13	24	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.4$ A, $V_{GEN} = 4.5$ V, $R_g = 1$ Ω	-	20	30			
Fall Time	t _f		-	11	20			
Drain-Source Body Diode Characterist	ics							
Pulse Diode Forward Current ^a	I _{SM}		-	-	2	A		
Body Diode Voltage	V _{SD}	I _S = 0.5 A	-	0.8	1.2	V		
Body Diode Reverse Recovery Time	t _{rr}		-	8	15	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	1	-	2	4	nC		
Reverse Recovery Fall Time	t _a	I _F = 0.4 A, dI/dt = 100 A/μs	-	4	-			
Reverse Recovery Rise Time	t _b	1	-	4	-	ns		

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

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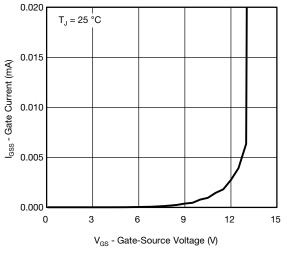
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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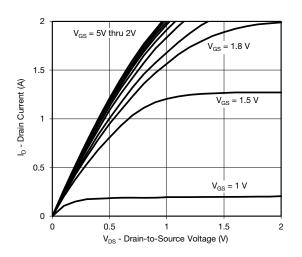


Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Gate Current vs. Gate-Source Voltage



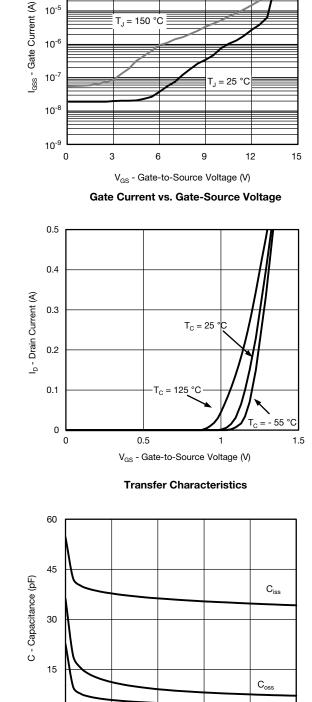
Output Characteristics

1

I_D - Drain Current (A)

V_{GS} = 1.5 V

0.5



V_{GS} = 1.8 V V_{GS} = 2.5 V $V_{GS} = 4.5 V$ C_{rss} 0 1.5 2 0 6 12 18 24 30 V_{DS} - Drain-to-Source Voltage (V) **On-Resistance vs. Drain Current** Capacitance 3

10⁻³

10⁻⁴

10⁻⁵

S14-0770-Rev. A, 14-Apr-14

1

0.8

0.6

0.4

0.2

0

 $R_{DS(on)}$ - On-Resistance (Ω)

Document Number: 64257

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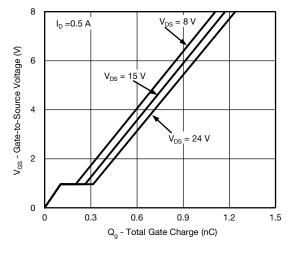
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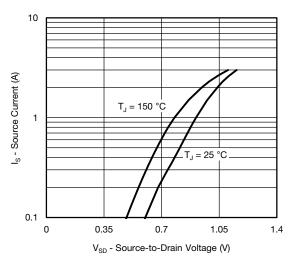


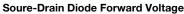
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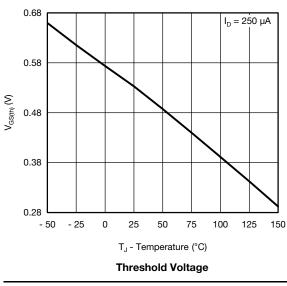
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)











1.8 $V_{GS} = 4.5$ 2.5 R_{DS(on)} - On-Resistance (Normalized) 1.5 V_{GS} = 1.8 V, 1.5 V 1.2 0.9 0.6 25 50 150

T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

75

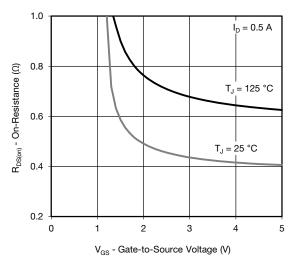
100

125

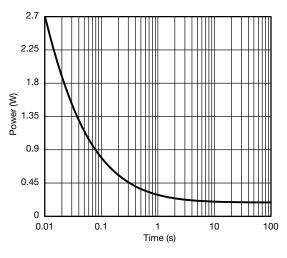
- 25

- 50

0







Single Pulse Power, Junction-to-Ambient

S14-0770-Rev. A, 14-Apr-14

Document Number: 64257

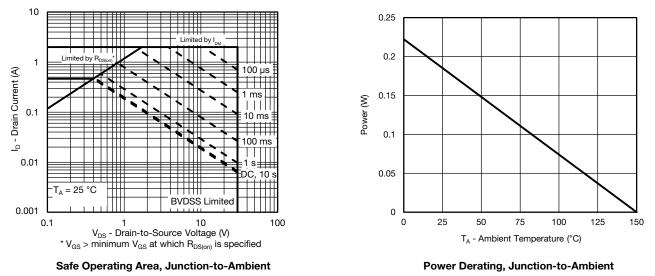
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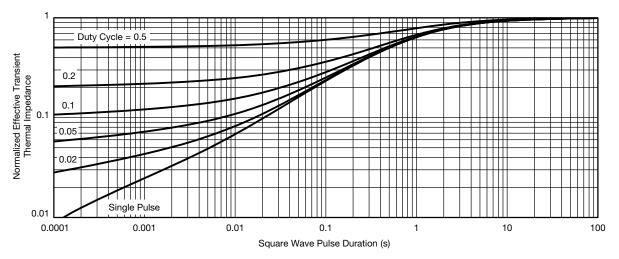


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Ambient

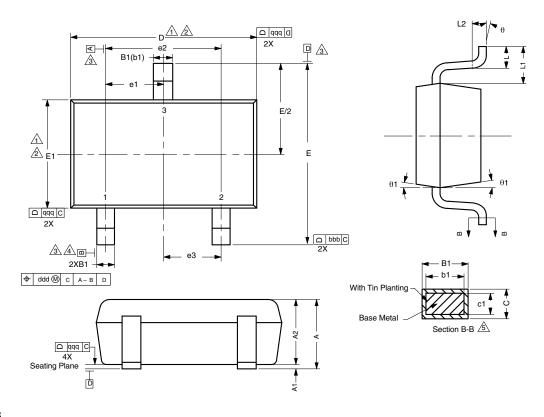
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S14-0770-Rev. A, 14-Apr-14	5	Document Number: 64257		
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Vishay Siliconix

SC-75A: 3 Leads



DWG: 5868

Notes

Dimensions in millimeters will govern.

- ⚠Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.
- 2 Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- A Datums A, B and D to be determined 0.10 mm from the lead tip.

A Terminal positions are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIMENSIONS	TOLERANCES		
aaa	0.10		
bbb	0.10		
ссс	0.10		
ddd	0.10		

DIM.	I	NOTE		
DIIVI.	MIN.	NOM.	MAX.	NOTE
А	-	-	0.80	
A1	0.00	-	0.10	
A2	0.65	0.70	0.80	
B1	0.19	-	0.24	5
b1	0.17	-	0.21	
с	0.13	-	0.15	5
c1	0.10	-	0.12	5
D	1.48	1.575	1.68	1, 2
E	1.50	1.60	1.70	
E1	0.66	0.76	0.86	1, 2
e1		0.50 BSC		
e2	1.00 BSC			
e3	0.50 BSC			
L	0.15	0.205	0.30	
L1	0.40 ref.			
L2	0.15 BSC			
q	0°	-	8°	
q1	4°	-	10°	

C15-1445-Rev. F, 23-Nov-15

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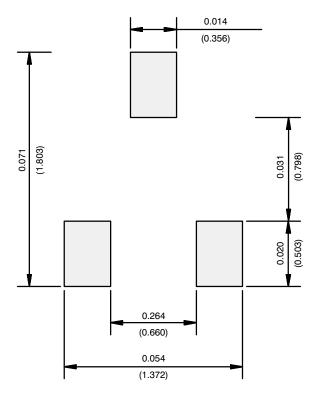
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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SC-75A: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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